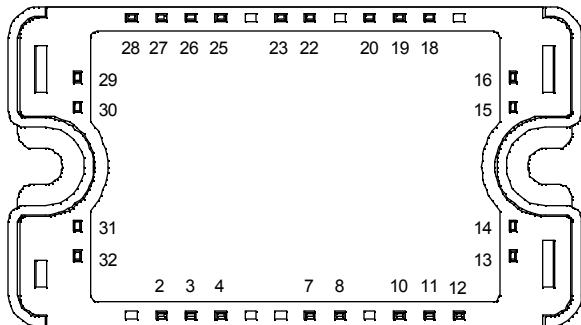
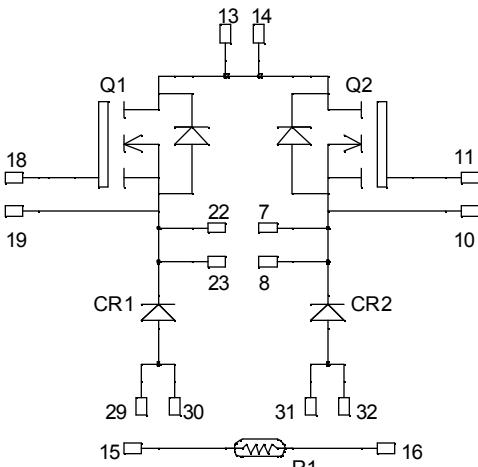


**Dual Buck chopper  
Super Junction MOSFET  
Power Module**

**V<sub>DSS</sub> = 800V**  
**R<sub>DSon</sub> = 290mΩ max @ T<sub>j</sub> = 25°C**  
**I<sub>D</sub> = 15A @ T<sub>c</sub> = 25°C**



All multiple inputs and outputs must be shorted together  
 Example: 13/14 ; 29/30 ; 22/23 ...

#### Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V <sub>DSS</sub>	Drain - Source Breakdown Voltage	800	V
I <sub>D</sub>	Continuous Drain Current	15	A
	T <sub>c</sub> = 80°C	11	
I <sub>DM</sub>	Pulsed Drain current	60	
V <sub>GS</sub>	Gate - Source Voltage	±30	V
R <sub>DSon</sub>	Drain - Source ON Resistance	290	mΩ
P <sub>D</sub>	Maximum Power Dissipation	156	W
I <sub>AR</sub>	Avalanche current (repetitive and non repetitive)	17	A
E <sub>AR</sub>	Repetitive Avalanche Energy	0.5	mJ
E <sub>AS</sub>	Single Pulse Avalanche Energy	670	

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed. See application note APTC80DSK29T3G – Rev 1 on [www.microsemi.com](http://www.microsemi.com)

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$ , $V_{DS} = 800\text{V}$	$T_j = 25^\circ\text{C}$			25	$\mu\text{A}$
		$V_{GS} = 0\text{V}$ , $V_{DS} = 800\text{V}$	$T_j = 125^\circ\text{C}$			250	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}$ , $I_D = 7.5\text{A}$				290	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 1\text{mA}$		2.1	3	3.9	$\text{V}$
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 20\text{ V}$ , $V_{DS} = 0\text{V}$				$\pm 100$	$\text{nA}$

**Dynamic Characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$			2254		$\text{pF}$
$C_{oss}$	Output Capacitance				1046		
$C_{rss}$	Reverse Transfer Capacitance				54		
$Q_g$	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 400\text{V}$ $I_D = 15\text{A}$			90		$\text{nC}$
$Q_{gs}$	Gate – Source Charge				11		
$Q_{gd}$	Gate – Drain Charge				45		
$T_{d(on)}$	Turn-on Delay Time	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ $V_{Bus} = 533\text{V}$ $I_D = 15\text{A}$ $R_G = 5\Omega$			10		$\text{ns}$
$T_r$	Rise Time				13		
$T_{d(off)}$	Turn-off Delay Time				83		
$T_f$	Fall Time				35		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 25°C</b> $V_{GS} = 15\text{V}$ , $V_{Bus} = 533\text{V}$ $I_D = 15\text{A}$ , $R_G = 5\Omega$			243		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy				139		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}$ , $V_{Bus} = 533\text{V}$ $I_D = 15\text{A}$ , $R_G = 5\Omega$			425		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy				171		

**Chopper diode ratings and characteristics**

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit	
$V_{RRM}$	Maximum Peak Repetitive Reverse Voltage	$V_R = 1000\text{V}$		1000			$\text{V}$	
$I_{RM}$	Maximum Reverse Leakage Current		$T_j = 25^\circ\text{C}$			250	$\mu\text{A}$	
			$T_j = 125^\circ\text{C}$			500		
$I_F$	DC Forward Current		$T_c = 65^\circ\text{C}$		30		$\text{A}$	
$V_F$	Diode Forward Voltage	$I_F = 30\text{A}$			1.9	2.3	$\text{V}$	
		$I_F = 60\text{A}$			2.2			
		$I_F = 30\text{A}$	$T_j = 125^\circ\text{C}$		1.7			
$t_{rr}$	Reverse Recovery Time	$I_F = 30\text{A}$ $V_R = 667\text{V}$ $di/dt = 200\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		290		$\text{ns}$	
			$T_j = 125^\circ\text{C}$		390			
$Q_{rr}$	Reverse Recovery Charge		$T_j = 25^\circ\text{C}$		670		$\text{nC}$	
			$T_j = 125^\circ\text{C}$		2350			

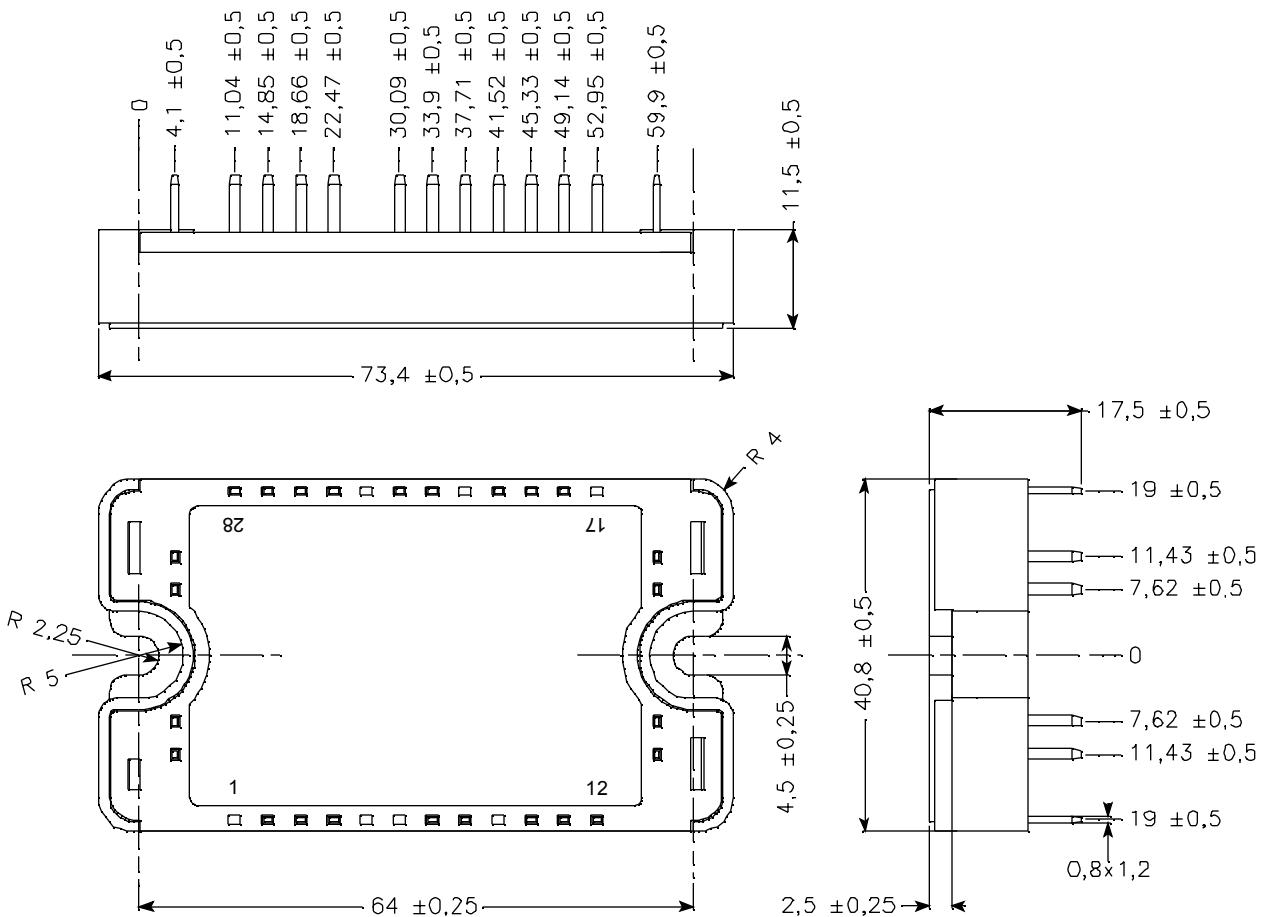
**Thermal and package characteristics**

Symbol	Characteristic		Min	Typ	Max	Unit
$R_{thJC}$	Junction to Case Thermal Resistance	Transistor			0.8	°C/W
		Diode			1.2	
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t = 1 min, $I_{isol} < 1\text{mA}$ , 50/60Hz	2500				V
$T_J$	Operating junction temperature range	-40		150		
$T_{STG}$	Storage Temperature Range	-40		125		°C
$T_C$	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink	M4	2.5	4.7	N.m
Wt	Package Weight				110	g

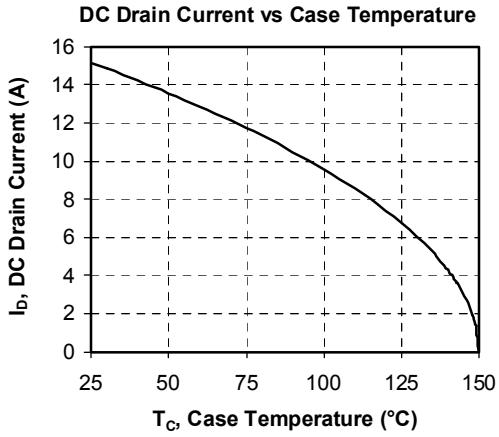
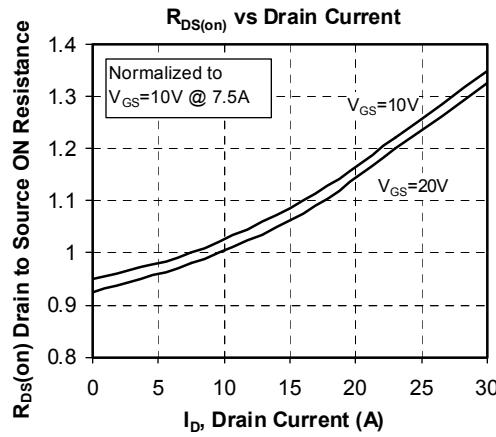
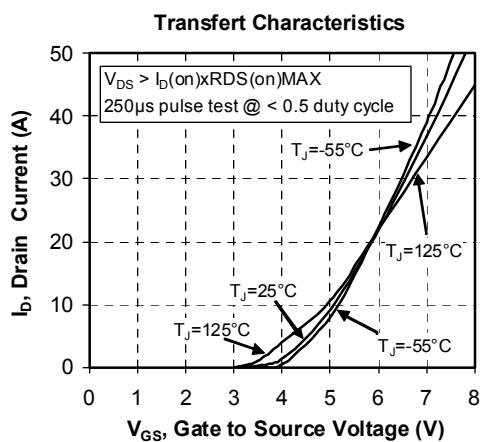
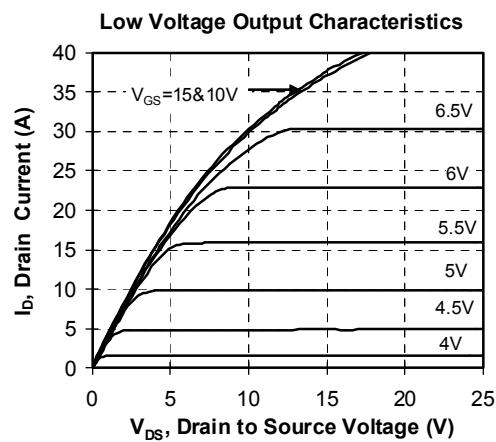
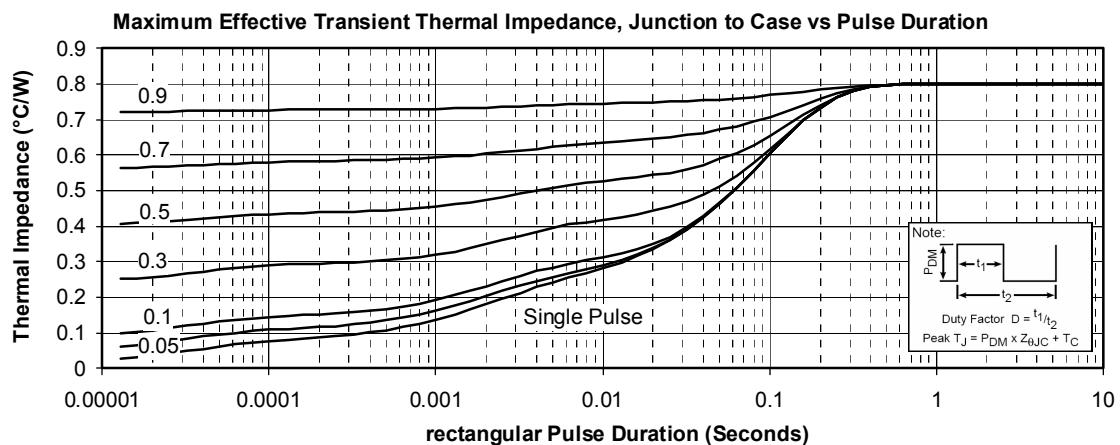
**Temperature sensor NTC** (see application note APT0406 on www.microsemi.com for more information).

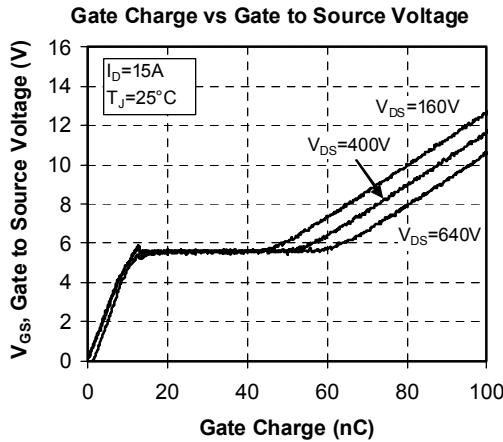
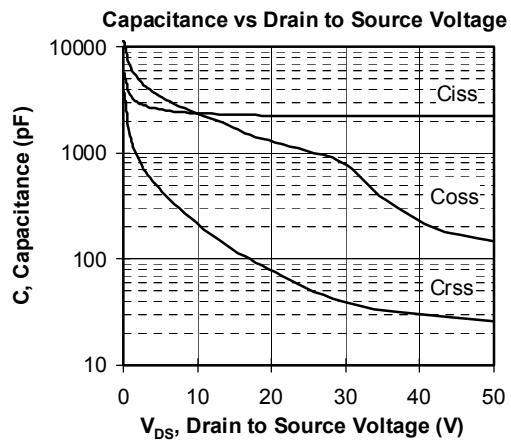
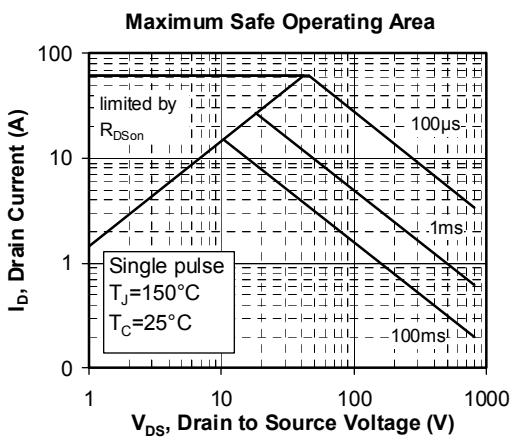
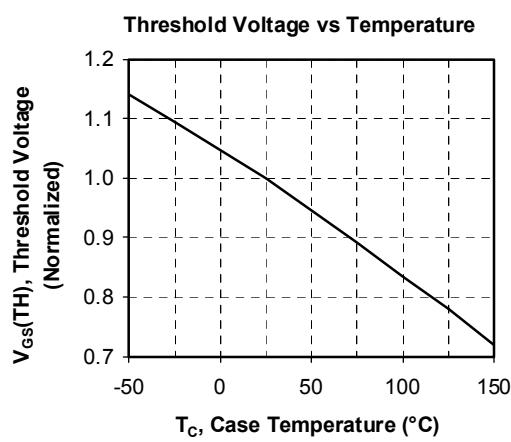
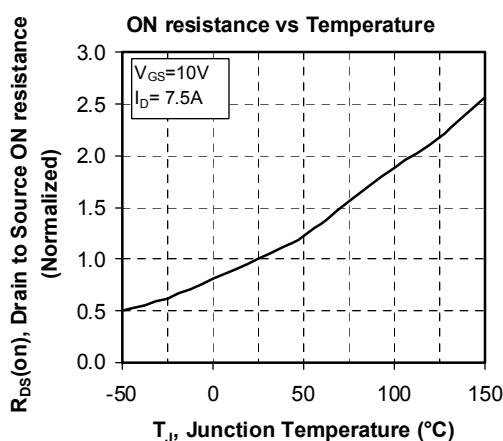
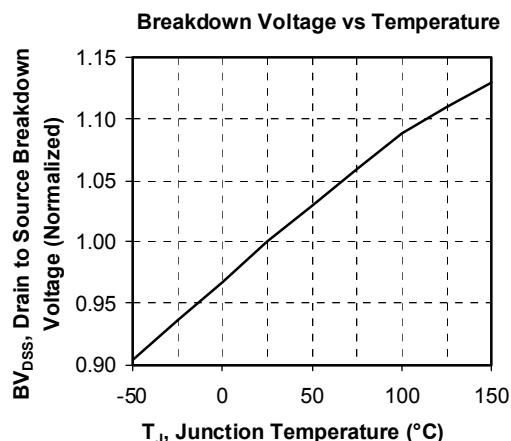
Symbol	Characteristic		Min	Typ	Max	Unit
$R_{25}$	Resistance @ 25°C			50		kΩ
$B_{25/85}$	$T_{25} = 298.15\text{ K}$			3952		K

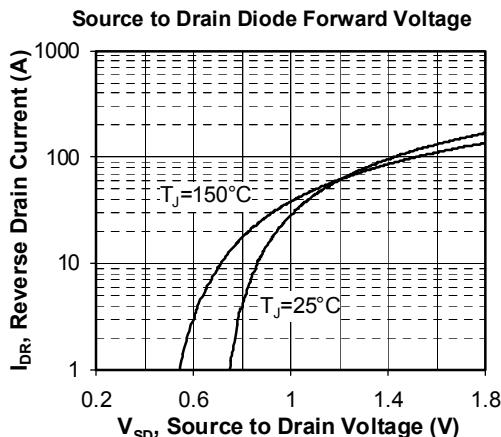
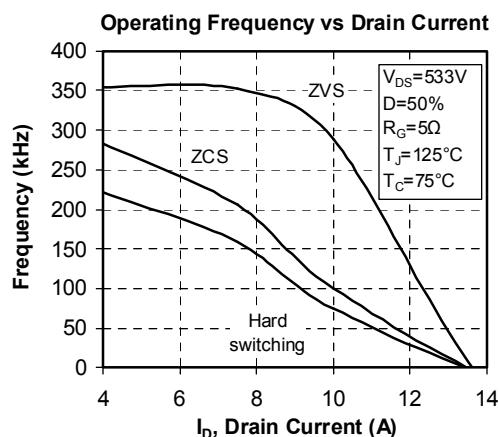
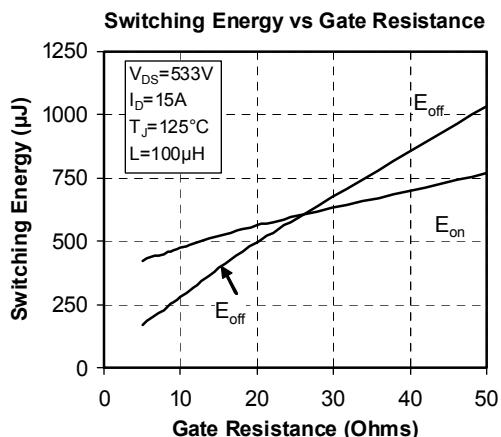
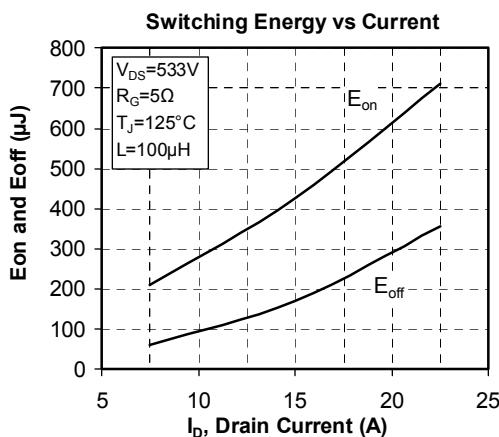
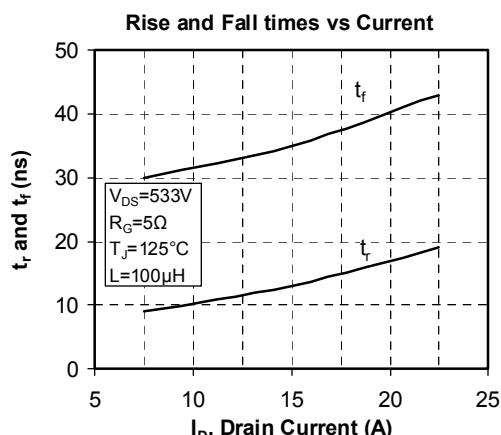
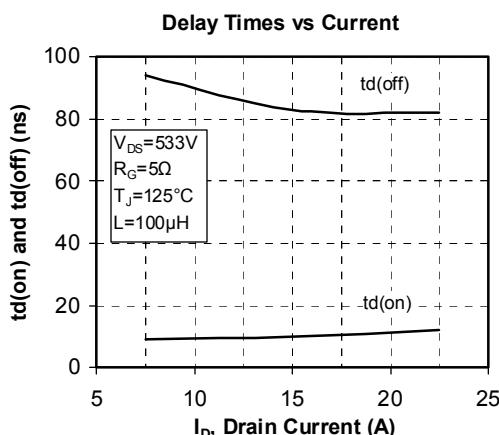
$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad T: \text{ Thermistor temperature } \\ R_T: \text{ Thermistor value at } T$$

**SP3 Package outline (dimensions in mm)**

 See application note 1901 - Mounting Instructions for SP3 Power Modules on [www.microsemi.com](http://www.microsemi.com)

### Typical performance Curve







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